### Australian ITk programme

James Webb



CDM annual meeting 29 November 2021

### \* Intense data collection phase \* Aim to increase $\mathscr{L}_{peak} = 7 \times 10^{34} \text{ cm}^{-2} \text{ s}^{-1}, 3000 \text{ -}$ $4000 \text{ fb}^{-1}$ data-set over ~10 year operation

\* 200 p-p collisions per beam crossing

## HL-LHC





## Towards a full silicon tracker

- \* Current inner-tracker (Pix, SCT, TRT) limited by readout rate and radiation damage, unsuitable for HL-LHC
- \* Moving to a fully silicon based tracker



# ITk strips

- Strip detector is comprised of two sections: barrel and the end-caps
- \* Redesign of inner tracker, extending geometry, sensitivity to larger  $\Delta \eta$
- New readout chips (ABCstar) and increased strip granularity



# Endcap petals

- \* End-caps comprised of 'petals'
- \* Each petal consists of six modules denoted R0 R5
- \* Melbourne to build R1 and R4 modules, early prototyping done with R0
- \* 32 petals comprise a single end-cap disk

### denoted R0 - R5 lules, early



## Module assembly

- Relatively simple design, full assembly requires only a few jigs.
- Gluing performed with stencil squeegee jig system.
- Hybrids to arrive pre-populated with ASICs (Not for prototyping).





### \* Controlling glue spread during hybrid gluing quite precarious \* Moving to gluing robot to ensure systematic glue application



# Module assembly II

# Module assembly III

- Two prototype R0 modules already assembled, a further module partially assembled.
- Electrical issues with current modules (large dark currents) a result of undesirable glue spread
- \* Readout chips, good functionality





# Module testing

- \* All electrical testing performed with generic FPGA boards.
- \* Electrical characterisation and thermal cycling to be performed at Adelaide.
- \* Cold-box for thermal cycling currently being built at DESY.





## Remote site qualification (QA)

- Due to pandemic, inperson site reviews not possible. Quick transition to online, piece-wise evaluation site evaluation.
- Production readiness QA
   well underway.
- On track for preproduction early next year.

	HV Tab Attach
	Sensor Reception
	PB Reception
	Hybrid Reception
	Module Assembly/Testing
	Module Shipping
	<u>General</u>
	Block
	Module Assembly/Testir
	Module Shipping
•	

Block

General Module Reception

	Step Number	Qualification Step	5	Status	Ready for Review?	Object Swapp	ed	Document Link	Video link	
	1.1	Bonding Procedures	Needs Developm	ent 🔹	No	No	٠	Malh	011rn	
	3.1	Sensor Reception	Needs Developm	ent 👻	No	No	•		oum	
	3.2	Sensor Storage	<b>Qualification Rea</b>	dy 👻	Yes	Not needed	•	https://www.dropl	oox.com/s/fboeh2	2jwe
	3.3	Sensor I-V	Review Docs Inco	omplete 👻	No	No	٠			
	6.1	PB Reception	Needs Developm	ent 🝷	No	No				
	6.2	PB E tests	Needs Developm	ent 💌	No	No	۳			
	6.3	PB Vis Insp	Needs Developm	ent 💌	No	No	•			
	6.4	PB Storage	Qualification Rea	dy 👻	Yes	Not needed	•	https://www.dropl	oox.com/s/fboeh2	2jwe
	10.1	Reception: hybrids	Needs Developm	ent 🔻	No	No	•			
	10.2	Storage of hybrids	Qualification Rea	dy 👻	Yes	Not needed	•	https://www.dropl	oox.com/s/fboeh2	2jwe
	8.7	Visual inspection: hybrids	Qualification Rea	dy 👻	Yes	Not needed	*	https://www.dropl	oox.com/s/afmm	7r2e
	8.11	hybrid QC: single panel testing	Requir	es Setup 🗸 🗸	No	No	-			
	11.1	Storage of modules	Qualification Rea	dy 👻	Yes	Not needed	•	https://www.dropl	oox.com/s/fboeh2	2jwe
	11.2	Cleaning module jigs	Qualification Rea	dy 👻	Yes	Not needed	•	https://www.dropl	box.com/s/ab5r5	d621
	11.4	Storage + shipping of glue	Requires Parts	•	No	No	•			
	11.5	Removing hybrids from panel	Needs Developm	ent 🔹	No	No	•			
	11.6	Module Assembly	Review Docs Inco	omplete 👻	No	No	•			
	11.7	Metrology: modules	Needs Developm	ent 🔹	No	No	•			
	11.8	Bonding procedures: modules	Needs Developm	ent 🔹	No	No	•			
	11.9	Visual inspection: modules	Qualification Rea	dy 👻	Yes	No	•	https://www.dropl	oox.com/s/va8aic	<u>142n</u>
Single 11.11 Electr		Single module Electrical Tests	Needs Developm	ent 🔹	No		•			
	12.1	12.1 Shipping modules		▼	No	No	•			
	13.1	Cleanroom standards	<b>Qualification Rea</b>	dy 👻	Yes	No	•	https://www.drop	https://www.drop	box.
	13.2	ASIC Compliance & Handling	Qualification Rea	dy 👻	Yes	No	•	https://www.dropl	box.com/s/1993r	8hw
	13.3	Bond Pulling Procedure	Qualification Rea	dy 👻	Yes	No	•	https://www.dropl	oox.com/s/a3u5ic	otlipe
	Step Numb	er Qualificat	ion Step	Status	Ready for Review	? Object Swapp	ed	Document Link	Video link	
	11.1	11.1 Storage of modules		Requires Setup	No		•			
nç	11.9	11.9 Visual inspection: m		Requires Setup	No				1.1.1.	
	11.10	11.10 Module Thermal Cy		Requires Setup	No		•	Aue	laiue	
	11.11	11.11 Single module Electrical Tests		Requires Setup	No		•			
	12.1	12.1 Shipping modules		Requires Setup	<ul> <li>No</li> </ul>		•			
	13.1	13.1 Cleanroom standard		Requires Setup	<ul> <li>No</li> </ul>		•			
	13.2	13.2 ASIC Compliance & Ha		Qualification Ready	✓ Yes	Not needed	•	Sent to Karola an	d Felix 15th July	202
	14.1	Module Reception		Needs Development	No		*			



### Future outlook

- \* On track to complete site qualification early next year.
- \* Pre-production (A/B) to follow (detector ready modules).
- \* Melbourne to produce 40 R1/R4 modules per year (2-3 year production run).
- \* See Scott Williams poster for more info on module assembly.

